

PBLS4001Y; PBLS4001V

40 V PNP BISS loadswitch

Rev. 01 — 8 November 2004

Product data sheet

1. Product profile

1.1 General description

Low V_{CEsat} PNP transistor and NPN resistor-equipped transistor in one package.

Table 1: Product overview

| Type number | Package | |
|-------------|---------|-------|
| | Philips | EIAJ |
| PBLS4001Y | SOT363 | SC-88 |
| PBLS4001V | SOT666 | - |

1.2 Features

- Low V_{CEsat} (BISS) and resistor-equipped transistor in one package
- Low 'threshold' voltage (< 1 V) compared to MOSFET
- Low drive power required
- Space-saving solution
- Reduction of component count.

1.3 Applications

- Supply line switches
- Battery charger switches
- High-side switches for LEDs, drivers and backlights
- Portable equipment.

1.4 Quick reference data

Table 2: Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|---------------------------|------------------------------------|-----|-----|------|------------|
| TR1; PNP: low V_{CEsat} transistor | | | | | | |
| V_{CEO} | collector-emitter voltage | open base | - | - | -40 | V |
| I_C | collector-current (DC) | | - | - | -500 | mA |
| R_{CEsat} | equivalent on-resistance | $I_C = -500$ mA; $I_B = -50$ mA | - | 440 | 700 | m Ω |
| TR2; NPN: resistor-equipped transistor | | | | | | |
| V_{CEO} | collector-emitter voltage | open base | - | - | 50 | V |

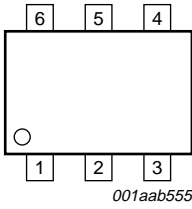
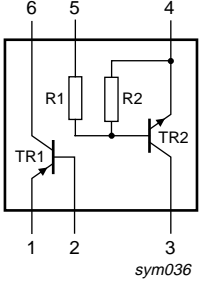
PHILIPS

Table 2: Quick reference data ...continued

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------|-------------------------|------------|------|-----|------|------------|
| I_o | output current (DC) | | - | - | 100 | mA |
| R1 | bias resistor 1 (input) | | 1.54 | 2.2 | 2.86 | k Ω |
| R2/R1 | bias resistor ratio | | 0.8 | 1 | 1.2 | |

2. Pinning information

Table 3: Discrete pinning

| Pin | Description | Simplified outline | Symbol |
|-----|------------------------|---|--|
| 1 | emitter TR1 |  <p>001aab555</p> |  <p>sym036</p> |
| 2 | base TR1 | | |
| 3 | output (collector) TR2 | | |
| 4 | GND (emitter) TR2 | | |
| 5 | input (base) TR2 | | |
| 6 | collector TR1 | | |

3. Ordering information

Table 4: Ordering information

| Type number | Package | | |
|-------------|---------|--|---------|
| | Name | Description | Version |
| PBLS4001Y | SC-88 | plastic surface mounted package; 6 leads | SOT363 |
| PBLS4001V | - | plastic surface mounted package; 6 leads | SOT666 |

4. Marking

Table 5: Marking codes

| Type number | Marking code [1] |
|-------------|------------------|
| PBLS4001Y | S1* |
| PBLS4001V | K1 |

[1] * = -: made in Hong Kong.
 * = t: made in Malaysia.
 * = W: made in China.

5. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|--|---------------------------|--|-----|------|------------------|
| TR1; PNP: low V_{CEsat} transistor | | | | | |
| V_{CBO} | collector-base voltage | open emitter | - | -40 | V |
| V_{CEO} | collector-emitter voltage | open base | - | -40 | V |
| V_{EBO} | emitter-base voltage | open collector | - | -6 | V |
| I_C | collector current (DC) | | - | -500 | mA |
| I_{CM} | peak collector current | $t_p \leq 1 \text{ ms}; \delta = 0.02$ | - | -1 | A |
| I_B | base current (DC) | | - | -50 | mA |
| I_{BM} | peak base current | $t_p \leq 1 \text{ ms}; \delta = 0.02$ | - | -100 | mA |
| P_{tot} | total power dissipation | $T_{amb} \leq 25 \text{ }^\circ\text{C}$ | [1] | 200 | mW |
| TR2; NPN: resistor-equipped transistor | | | | | |
| V_{CBO} | collector-base voltage | open emitter | - | 50 | V |
| V_{CEO} | collector-emitter voltage | open base | - | 50 | V |
| V_{EBO} | emitter-base voltage | open collector | - | 10 | V |
| V_I | input voltage | | | | |
| | positive | | - | +12 | V |
| | negative | | - | -10 | V |
| I_O | output current (DC) | | - | 100 | mA |
| I_{CM} | peak collector current | | - | 100 | mA |
| P_{tot} | total power dissipation | $T_{amb} \leq 25 \text{ }^\circ\text{C}$ | [1] | 200 | mW |
| Per device | | | | | |
| P_{tot} | total power dissipation | | - | 300 | mW |
| T_{stg} | storage temperature | | -65 | +150 | $^\circ\text{C}$ |
| T_j | junction temperature | | - | 150 | $^\circ\text{C}$ |
| T_{amb} | ambient temperature | | -65 | +150 | $^\circ\text{C}$ |

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7: Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------|---|-------------|--------|-----|-----|------|
| Per device | | | | | | |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | | | | |
| | SOT363 | | [1] | - | 416 | K/W |
| | SOT666 | | [1][2] | - | 416 | K/W |

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

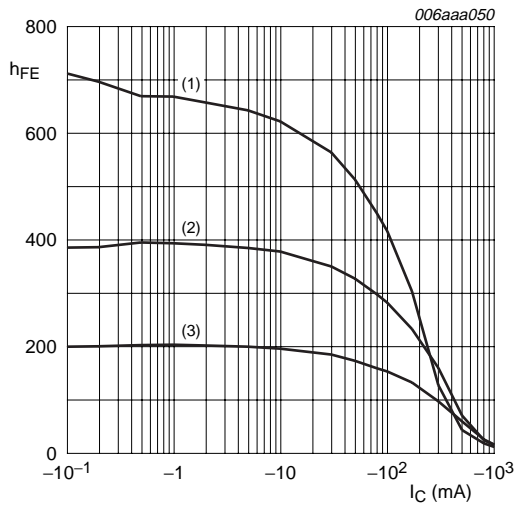
[2] Reflow soldering is the only recommended soldering method.

7. Characteristics

Table 8: Characteristics
T_{amb} = 25 °C unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|--------------------------------------|---|---------|-----|------|------|
| TR1; PNP: low V_{CEsat} transistor | | | | | | |
| I _{CBO} | collector-base cut-off current | V _{CB} = -40 V; I _E = 0 A | - | - | -100 | nA |
| | | V _{CB} = -40 V; I _E = 0 A; T _j = 150 °C | - | - | -50 | μA |
| I _{EBO} | emitter-base cut-off current | V _{EB} = -5 V; I _C = 0 A | - | - | -100 | nA |
| h _{FE} | DC current gain | V _{CE} = -2 V; I _C = -10 mA | 200 | - | - | |
| | | V _{CE} = -2 V; I _C = -100 mA | [1] 150 | - | - | |
| | | V _{CE} = -2 V; I _C = -500 mA | [1] 40 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | I _C = -10 mA; I _B = -0.5 mA | - | - | -50 | mV |
| | | I _C = -100 mA; I _B = -5 mA | - | - | -130 | mV |
| | | I _C = -200 mA; I _B = -10 mA | - | - | -200 | mV |
| | | I _C = -500 mA; I _B = -50 mA | [1] - | - | -350 | mV |
| R _{CEsat} | equivalent on-resistance | I _C = -500 mA; I _B = -50 mA | [1] - | 440 | 700 | mΩ |
| V _{BEsat} | base-emitter saturation voltage | I _C = -500 mA; I _B = -50 mA | [1] - | - | -1.2 | V |
| V _{BEon} | base-emitter turn-on voltage | V _{CE} = -2 V; I _C = -100 mA | [1] - | - | -1.1 | V |
| f _T | transition frequency | I _C = -100 mA; V _{CE} = -5 V; f = 100 MHz | 100 | 300 | - | MHz |
| C _c | collector capacitance | V _{CB} = -10 V; I _E = i _e = 0 A; f = 1 MHz | - | - | 10 | pF |
| TR2; NPN: resistor-equipped transistor | | | | | | |
| I _{CBO} | collector-base cut-off current | V _{CB} = 50 V; I _E = 0 A | - | - | 100 | nA |
| I _{CEO} | collector-emitter cut-off current | V _{CE} = 30 V; I _B = 0 A | - | - | 1 | μA |
| | | V _{CE} = 30 V; I _B = 0 A; T _j = 150 °C | - | - | 50 | μA |
| I _{EBO} | emitter-base cut-off current | V _{EB} = 5 V; I _C = 0 A | - | - | 2 | mA |
| h _{FE} | DC current gain | V _{CE} = 5 V; I _C = 20 mA | 30 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | I _C = 10 mA; I _B = 0.5 mA | - | - | 150 | mV |
| V _{I(off)} | off-state input voltage | V _{CE} = 5 V; I _C = 1 mA | - | 1.2 | 0.5 | V |
| V _{I(on)} | on-state input voltage | V _{CE} = 0.3 V; I _C = 20 mA | 2 | 1.6 | - | V |
| R1 | bias resistor 1 (input) | | 1.54 | 2.2 | 2.86 | kΩ |
| R2/R1 | bias resistor ratio | | 0.8 | 1 | 1.2 | |
| C _c | collector capacitance | V _{CB} = 10 V; I _E = i _e = 0 A; f = 1 MHz | - | - | 2.5 | pF |

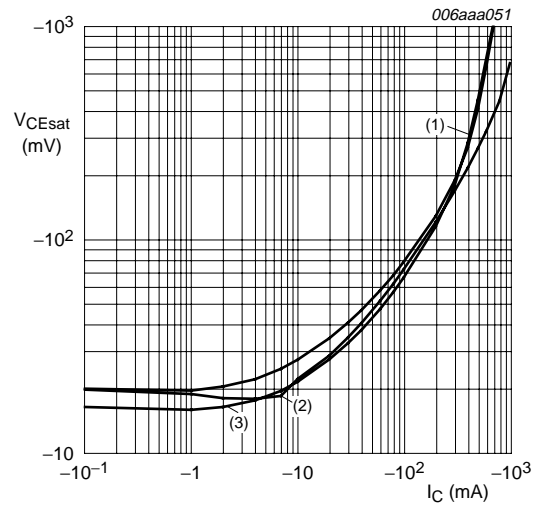
[1] Pulse test: t_p ≤ 300 μs; δ ≤ 0.02.



$V_{CE} = -2\text{ V}$.

- (1) $T_{amb} = 150^\circ\text{C}$.
- (2) $T_{amb} = 25^\circ\text{C}$.
- (3) $T_{amb} = -55^\circ\text{C}$.

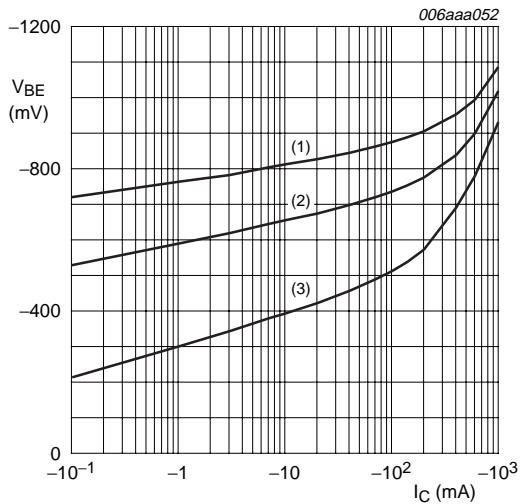
Fig 1. TR1 (PNP): DC current gain as a function of collector current; typical values.



$I_C/I_B = 20$.

- (1) $T_{amb} = 150^\circ\text{C}$.
- (2) $T_{amb} = 25^\circ\text{C}$.
- (3) $T_{amb} = -55^\circ\text{C}$.

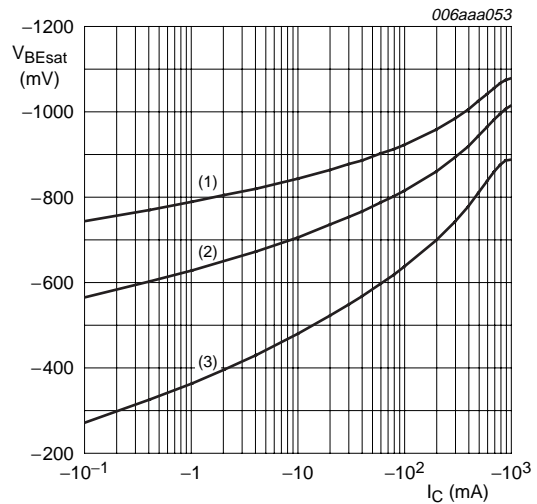
Fig 2. TR1 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values.



$V_{CE} = -2\text{ V}$.

- (1) $T_{amb} = -55^\circ\text{C}$.
- (2) $T_{amb} = 25^\circ\text{C}$.
- (3) $T_{amb} = 150^\circ\text{C}$.

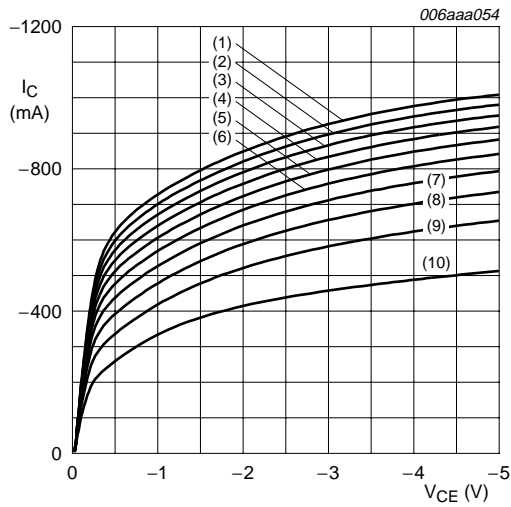
Fig 3. TR1 (PNP): Base-emitter voltage as a function of collector current; typical values.



$I_C/I_B = 20$.

- (1) $T_{amb} = 150^\circ\text{C}$.
- (2) $T_{amb} = 25^\circ\text{C}$.
- (3) $T_{amb} = -55^\circ\text{C}$.

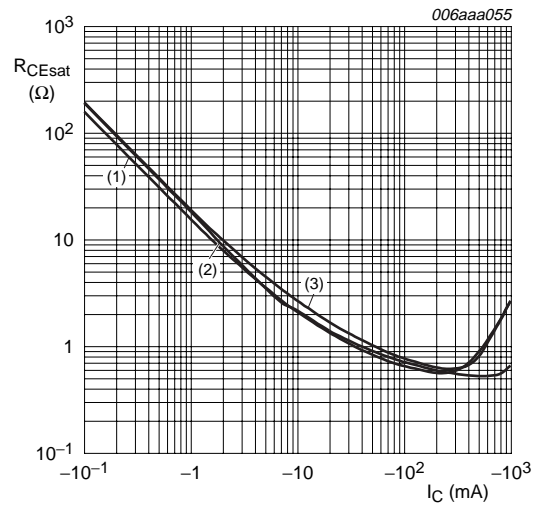
Fig 4. TR1 (PNP): Base-emitter saturation voltage as a function of collector current; typical values.



$T_{amb} = 25\text{ °C.}$

- (1) $I_B = -40\text{ mA.}$
- (2) $I_B = -36\text{ mA.}$
- (3) $I_B = -32\text{ mA.}$
- (4) $I_B = -28\text{ mA.}$
- (5) $I_B = -24\text{ mA.}$
- (6) $I_B = -20\text{ mA.}$
- (7) $I_B = -16\text{ mA.}$
- (8) $I_B = -12\text{ mA.}$
- (9) $I_B = -8\text{ mA.}$
- (10) $I_B = -4\text{ mA.}$

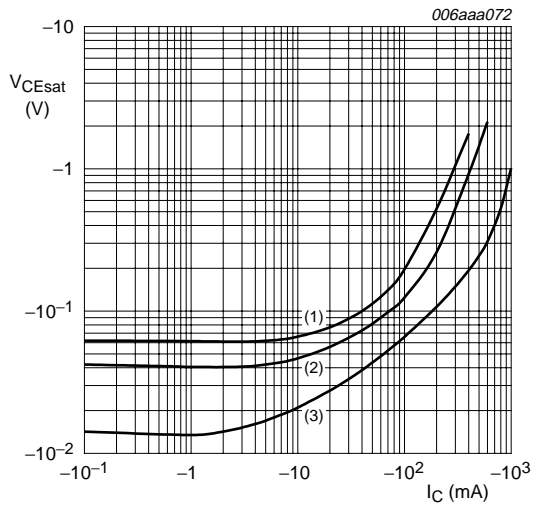
Fig 5. TR1 (PNP): Collector current as a function of collector-emitter voltage; typical values.



$I_C/I_B = 20.$

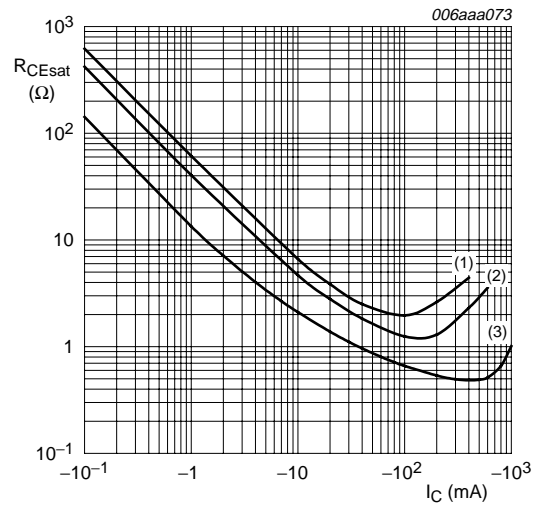
- (1) $T_{amb} = -55\text{ °C.}$
- (2) $T_{amb} = 25\text{ °C.}$
- (3) $T_{amb} = 150\text{ °C.}$

Fig 6. TR1 (PNP): Equivalent on-resistance as a function of collector current; typical values.



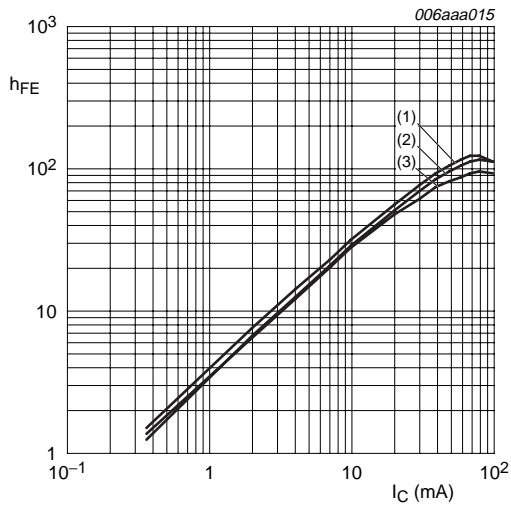
- $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (1) $I_C/I_B = 10.$
 - (2) $I_C/I_B = 50.$
 - (3) $I_C/I_B = 100.$

Fig 7. TR1 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values.



- $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (1) $I_C/I_B = 10.$
 - (2) $I_C/I_B = 50.$
 - (3) $I_C/I_B = 100.$

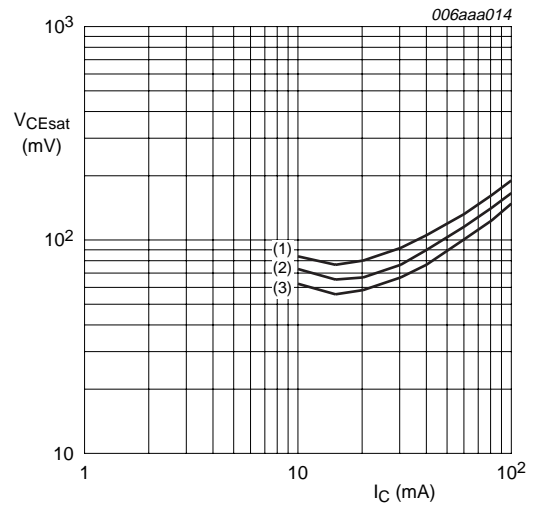
Fig 8. TR1 (PNP): Equivalent-on resistance as a function of collector current; typical values.



$V_{CE} = 5 \text{ V.}$

- (1) $T_{amb} = 150 \text{ }^\circ\text{C.}$
- (2) $T_{amb} = 25 \text{ }^\circ\text{C.}$
- (3) $T_{amb} = -40 \text{ }^\circ\text{C.}$

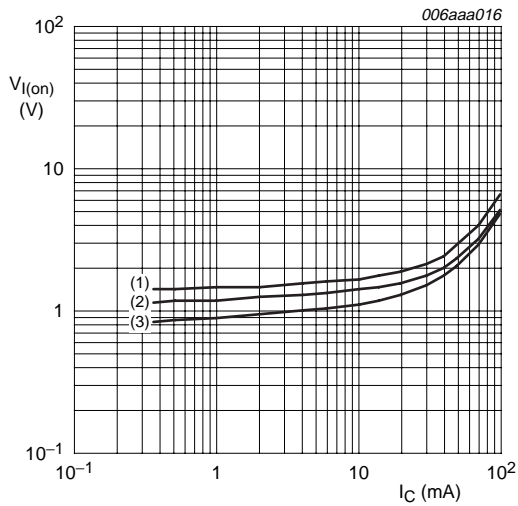
Fig 9. TR2 (NPN): DC current gain as a function of collector current; typical values.



$I_C/I_B = 20.$

- (1) $T_{amb} = 100 \text{ }^\circ\text{C.}$
- (2) $T_{amb} = 25 \text{ }^\circ\text{C.}$
- (3) $T_{amb} = -40 \text{ }^\circ\text{C.}$

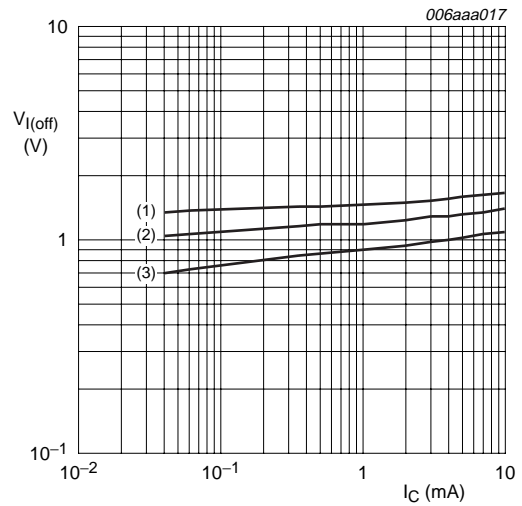
Fig 10. TR2 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values.



$V_{CE} = 0.3 \text{ V.}$

- (1) $T_{amb} = -40 \text{ }^\circ\text{C.}$
- (2) $T_{amb} = 25 \text{ }^\circ\text{C.}$
- (3) $T_{amb} = 100 \text{ }^\circ\text{C.}$

Fig 11. TR2 (NPN): On-state input voltage as a function of collector current; typical values.



$V_{CE} = 5 \text{ V.}$

- (1) $T_{amb} = -40 \text{ }^\circ\text{C.}$
- (2) $T_{amb} = 25 \text{ }^\circ\text{C.}$
- (3) $T_{amb} = 100 \text{ }^\circ\text{C.}$

Fig 12. TR2 (NPN): Off-state input voltage as a function of collector current; typical values.

8. Package outline

Plastic surface mounted package; 6 leads

SOT363

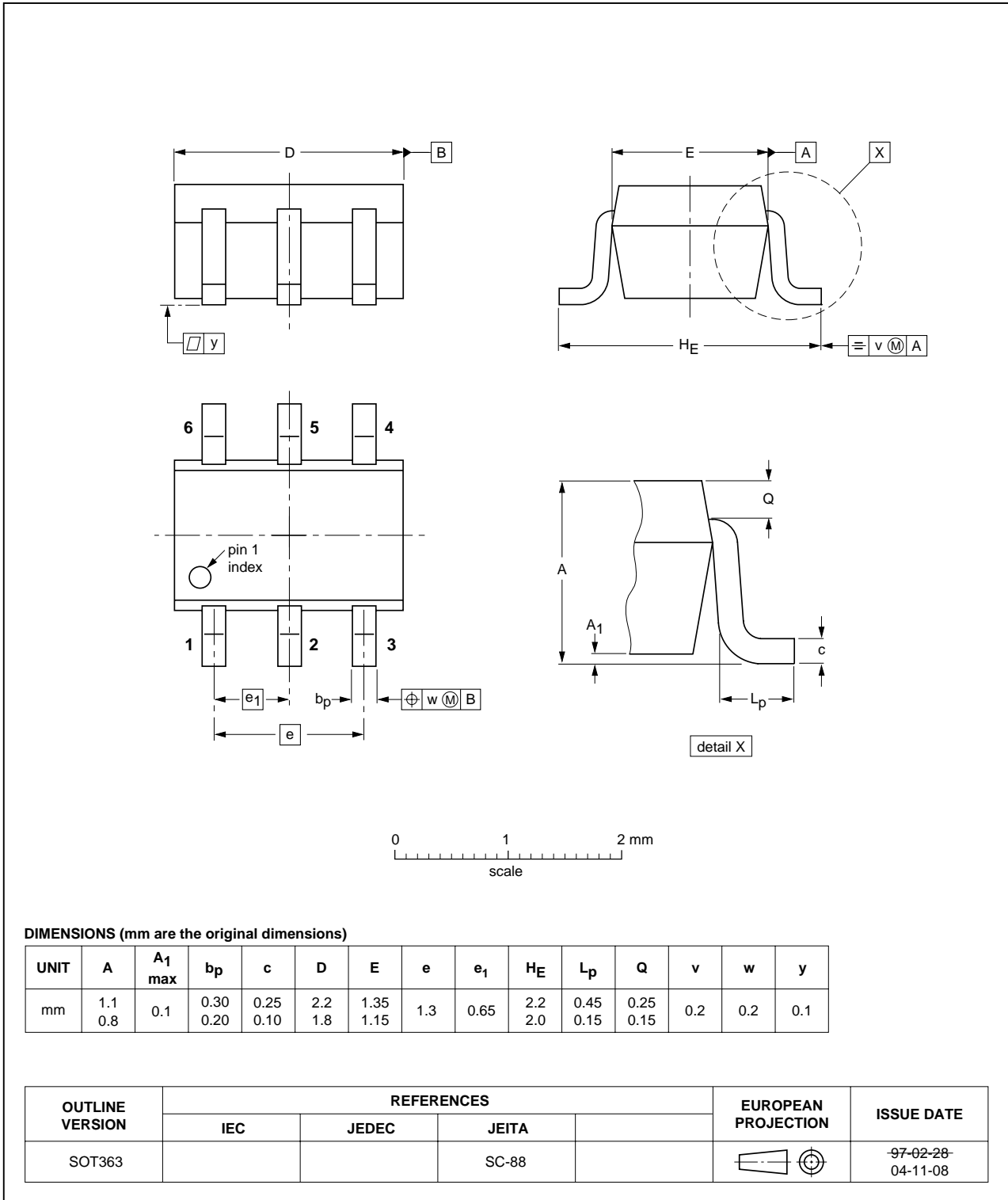


Fig 13. Package outline SOT363 (SC-88).

Plastic surface mounted package; 6 leads

SOT666

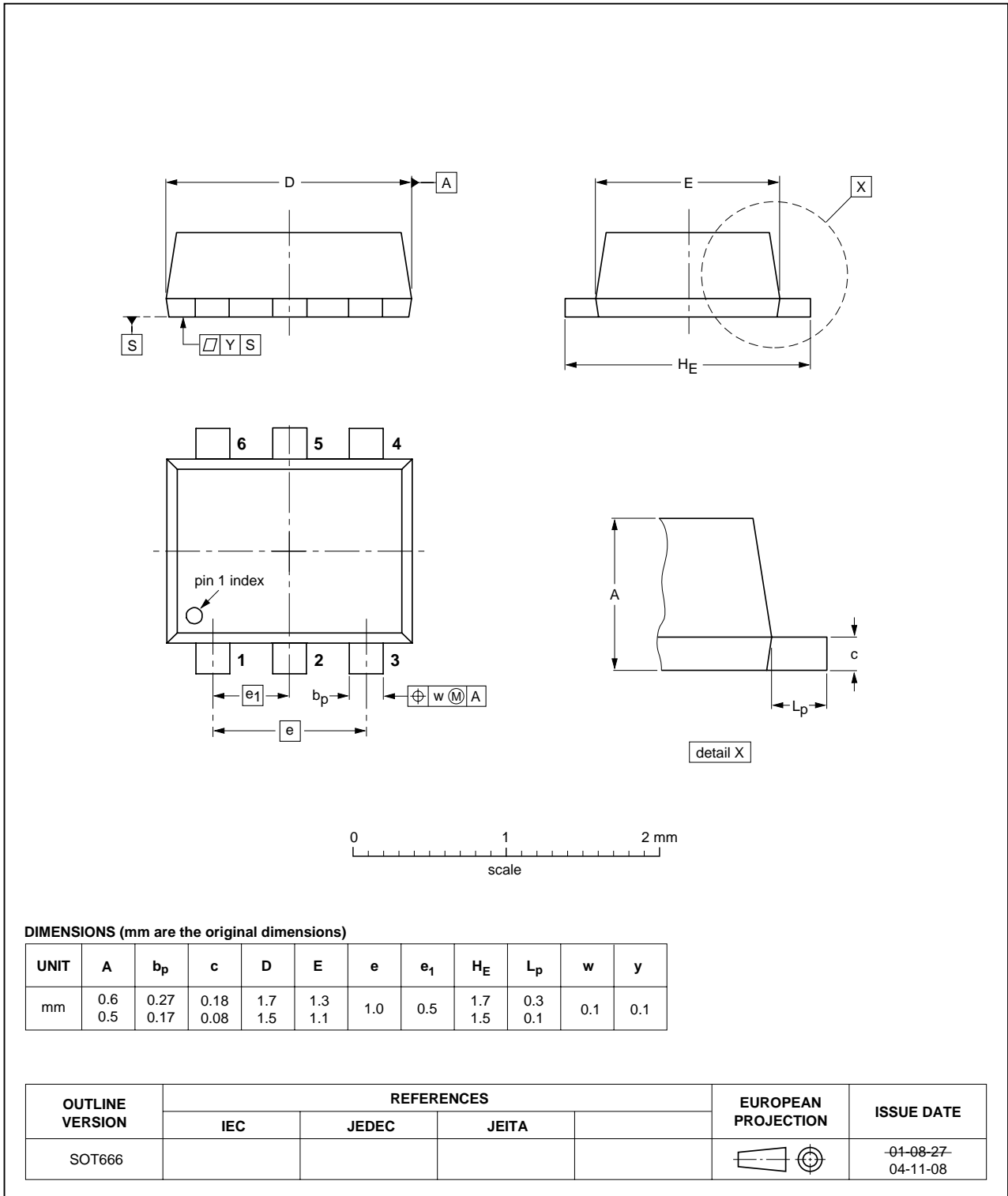


Fig 14. Package outline SOT666.

9. Packing information

Table 9: Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [\[1\]](#)

| Type number | Package | Description | Packing quantity | | |
|-------------|---------|------------------------------------|--------------------------|------|-------|
| | | | 3000 | 4000 | 10000 |
| PBL4001Y | SOT363 | 4 mm pitch, 8 mm tape and reel; T1 | [2] -115 | - | -135 |
| | | 4 mm pitch, 8 mm tape and reel; T2 | [3] -125 | - | -165 |
| PBL4001V | SOT666 | 4 mm pitch, 8 mm tape and reel | - | -115 | - |

[1] For further information and the availability of packing methods, see [Section 14](#).

[2] T1: normal taping.

[3] T2: reverse taping.

10. Revision history

Table 10: Revision history

| Document ID | Release date | Data sheet status | Change notice | Order number | Supersedes |
|-----------------------|--------------|--------------------|---------------|----------------|------------|
| PBL54001Y_PBL54001V_1 | 20041108 | Product data sheet | - | 9397 750 13454 | - |

11. Data sheet status

| Level | Data sheet status ^[1] | Product status ^[2] ^[3] | Definition |
|-------|----------------------------------|--|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
| II | Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product. |
| III | Product data | Production | This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). |

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

12. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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For sales office addresses, send an email to: sales.addresses@www.semiconductors.philips.com

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